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Description

The DIODES™ DGTD120T40S1PT is produced using advanced Field Stop Trench IGBT Technology, which provides low $V_{CE(sat)}$, excellent quality and high switching performance.

Features

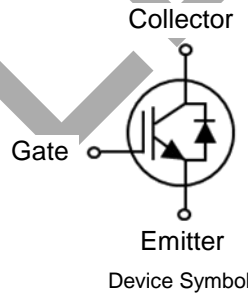
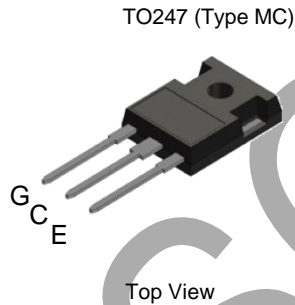
- High-Speed Switching & Low Power Loss
- $V_{CE(sat)} = 2.0V @ I_C = 40A$
- High Input Impedance
- $t_{rr} = 100ns$ (Typ) @ $dI_F/dt = 200A/\mu s$
- Ultra Soft, Fast Recovery Anti-Parallel Diode
- Ultra Narrowed V_F Distribution Control
- **Lead-Free Finish & RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Applications

- Motor drives
- UPS
- Solar inverters
- IH cookers

Mechanical Data

- Package: TO247
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminals: Finish – Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 5.6 grams (Approximate)



Ordering Information (Note 4)

Part Number	Package	Marking	Packing	
			Qty.	Carrier
DGTD120T40S1PT	TO247 (Type MC)	DGTD120T40S1	450	Per Box in Tubes (Note 5)

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
 5. 30 devices per tube.

Marking Information



D; ; = Manufacturer's Marking
 DGTD120T40S1 = Product Type Marking Code
 YY = Year (ex: 22 = 2022)
 LLLLL = Lot Code
 WW = Week (01 to 53)

Absolute Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CE}	1200	V
DC Collector Current	I_C	$T_C = +25^\circ\text{C}$	A
		$T_C = +100^\circ\text{C}$	A
Pulsed Collector Current, t_p Limited by T_{vjmax}	I_{CM}	160	A
Diode Forward Current	I_F	$T_C = +25^\circ\text{C}$	A
		$T_C = +100^\circ\text{C}$	A
Diode Pulsed Current, t_p Limited by T_{vjmax}	I_{FM}	160	A
Gate-Emitter Voltage	V_{GES}	± 20	V
Short Circuit Withstand Time $V_{CC} \leq 600\text{V}$, $V_{GE} = 15\text{V}$, $T_{vj} = +150^\circ\text{C}$ Allowed Number of Short Circuits < 1000 Time Between Short Circuits $\geq 1.0\text{s}$	t_{sc}	10	μs

Thermal Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 6)	P_D	$T_C = +25^\circ\text{C}$	W
		$T_C = +100^\circ\text{C}$	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	40	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case for IBGT (Note 6)	$R_{\theta JC}$	0.35	
Thermal Resistance, Junction to Case for Diode (Note 6)	$R_{\theta JC}$	0.80	
Operating Temperature	T_{vj}	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	

Note: 6. When mounted on a standard JEDEC 2-layer FR-4 board.

Electrical Characteristics (@T_{vj} = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Typ	Max	Unit	Condition	
STATIC CHARACTERISTICS							
Collector-Emitter Breakdown Voltage	BV _{CES}	1,200	—	—	V	I _C = 1mA, V _{GE} = 0V	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	—	T _{vj} = +25°C	2.00	2.40	V	I _C = 40A, V _{GE} = 15V
			T _{vj} = +150°C	2.45	—		
Diode Forward Voltage	V _F	—	T _{vj} = +25°C	2.40	3.00	V	I _F = 40A
			T _{vj} = +150°C	2.45	—		
Gate-Emitter Threshold Voltage	V _{GE(th)}	4.5	5.5	6.5	V	V _{CE} = V _{GE} , I _C = 1mA	
Zero Gate Voltage Collector Current	I _{CES}	—	—	1.0	mA	V _{CE} = 1200V, V _{GE} = 0V	
Gate-Emitter Leakage Current	I _{GES}	—	—	±250	nA	V _{GE} = 20V, V _{CE} = 0V	
DYNAMIC CHARACTERISTICS							
Total Gate Charge	Q _g	—	341	—	nC	V _{CE} = 600V, I _C = 40A V _{GE} = 15V	
Gate-Emitter Charge	Q _{ge}	—	52	—			
Gate-Collector Charge	Q _{gc}	—	126	—			
Input Capacitance	C _{ies}	—	6,030	—	pF	V _{CE} = 30V, V _{GE} = 0V f = 1MHz	
Reverse Transfer Capacitance	C _{res}	—	107	—			
Output Capacitance	C _{oes}	—	206	—			
SWITCHING CHARACTERISTICS							
Turn-on Delay Time	t _{d(on)}	—	65	—	ns	V _{GE} = 15V, V _{CC} = 600V I _C = 40A, R _G = 10Ω Inductive Load T _{vj} = +25°C	
Rise Time	t _r	—	55	—			
Turn-off Delay Time	t _{d(off)}	—	308	—			
Fall Time	t _f	—	40	—	mJ		
Turn-on Switching Energy	E _{on}	—	1.96	—			
Turn-off Switching Energy	E _{off}	—	0.54	—			
Total Switching Energy	E _{ts}	—	2.50	—	ns	I _F = 40A dI _F /dt = 200A/μs T _{vj} = +25°C	
Reverse Recovery Time	t _{rr}	—	100	—			
Reverse Recovery Current	I _{rr}	—	7	—			
Reverse Recovery Charge	Q _{rr}	—	350	—	nC		
Turn-on Delay Time	t _{d(on)}	—	70	—			
Rise Time	t _r	—	62	—		ns	V _{GE} = 15V, V _{CC} = 600V I _C = 40A, R _G = 10Ω Inductive Load T _{vj} = +150°C
Turn-off Delay Time	t _{d(off)}	—	325	—			
Fall Time	t _f	—	62	—	mJ		
Turn-on Switching Energy	E _{on}	—	2.35	—			
Turn-off Switching Energy	E _{off}	—	1.61	—			
Total Switching Energy	E _{ts}	—	3.96	—	ns	I _F = 40A dI _F /dt = 200A/μs T _{vj} = +150°C	
Reverse Recovery Time	t _{rr}	—	180	—			
Reverse Recovery Current	I _{rr}	—	10	—			
Reverse Recovery Charge	Q _{rr}	—	900	—	nC		

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Typical Performance Characteristics (@T_A = +25°C, unless otherwise specified.)

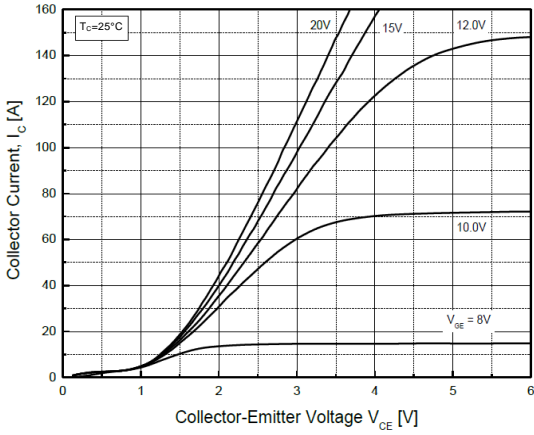


Fig.1 Typical Output Characteristics

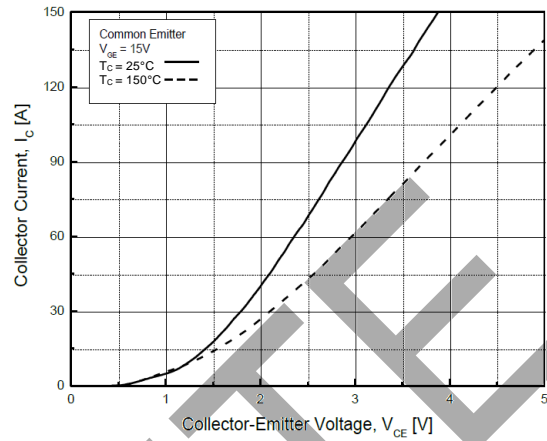


Fig.2 Typical Collector-Emitter Saturation Voltage

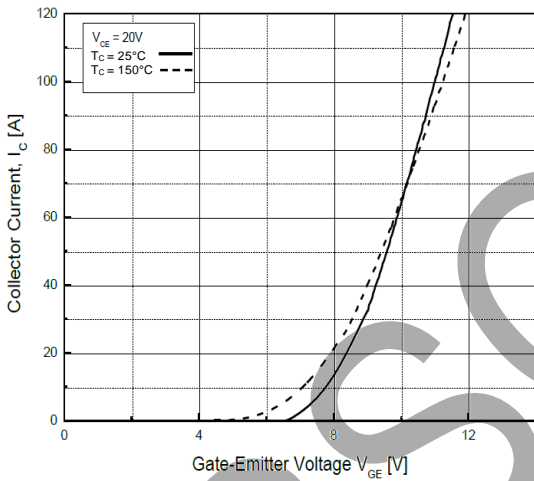


Fig.3 Typical Transfer Characteristics

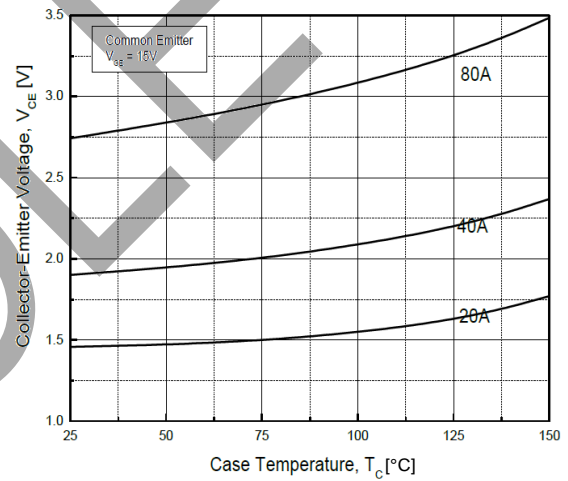


Fig.4 Typical Collector-Emitter Saturation Voltage at Case Temperature

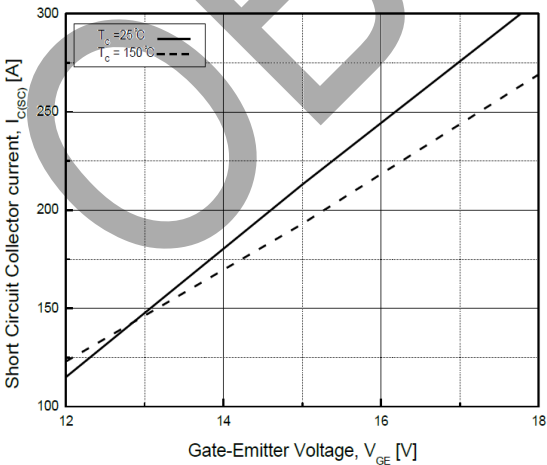


Fig.5 Typical Short Circuit Collector Current

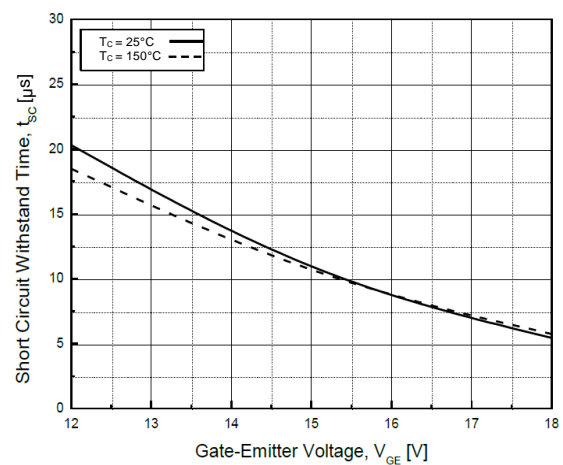


Fig.6 Typical Short Circuit Withstand Time

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Typical Performance Characteristics (continued)

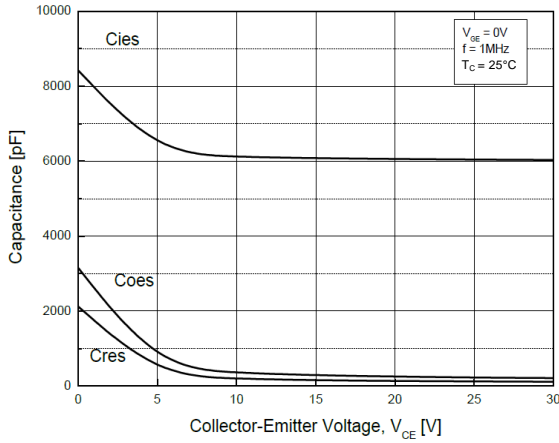


Fig.7 Typical Capacitance

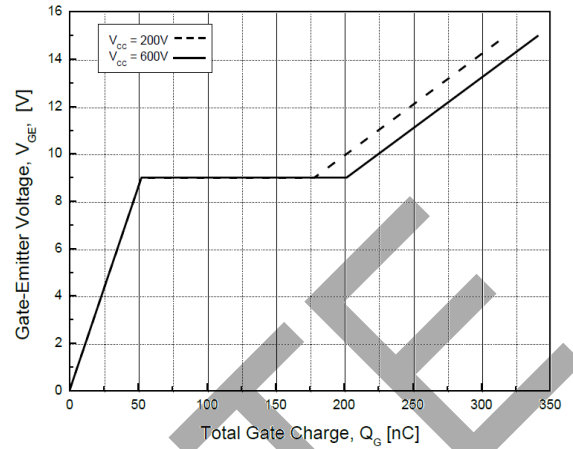


Fig.8 Typical Gate Charge

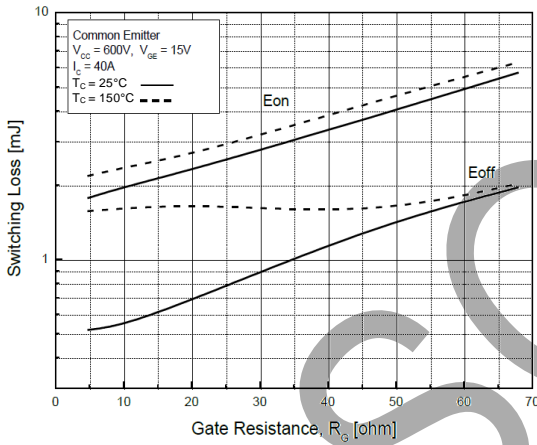


Fig.9 Switching Loss-Gate Resistance

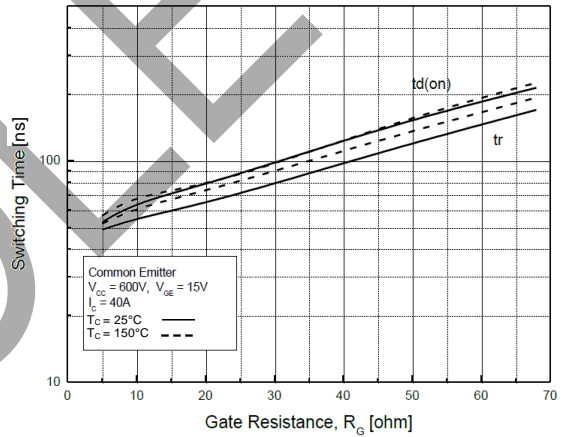


Fig.10 Turn on Characteristics-Gate Resistance

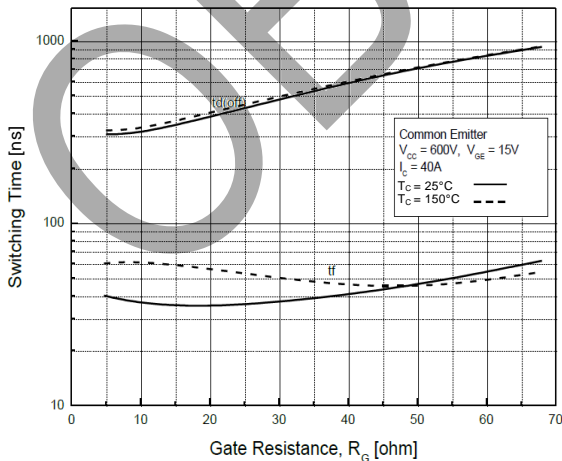


Fig.11 Turn off Characteristics-Gate Resistance

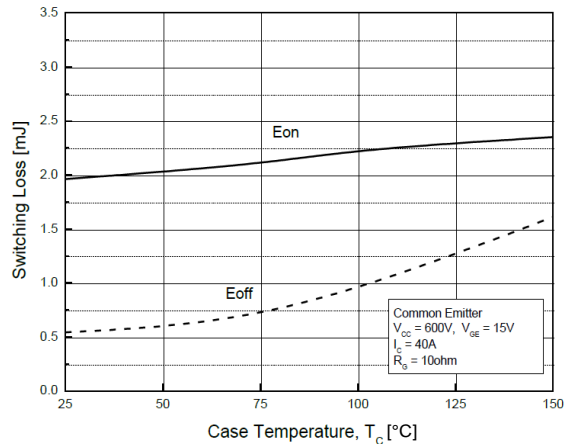


Fig.12 Switching Loss-Case Temperature

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Typical Performance Characteristics (continued)

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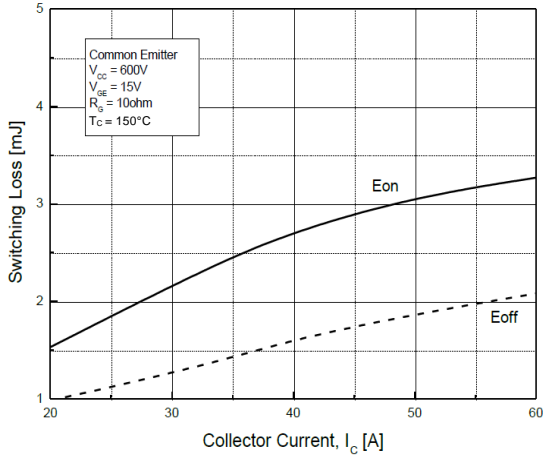


Fig.13 Switching Loss-Collector Current

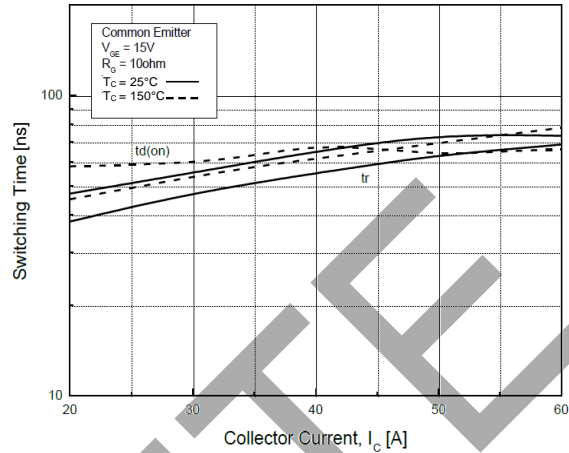


Fig.14 Typical Turn on-Collector Current

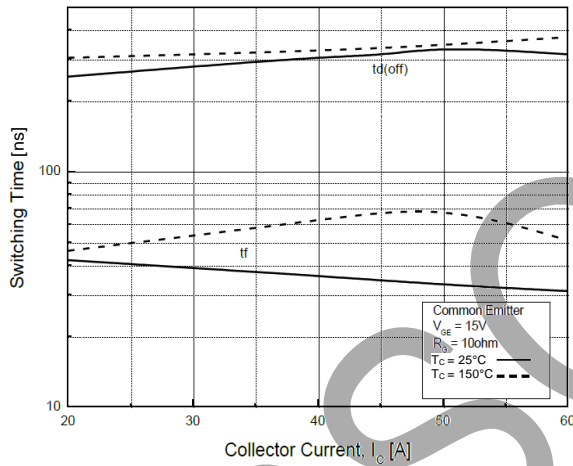


Fig.15 Typical Turn off-Collector Current

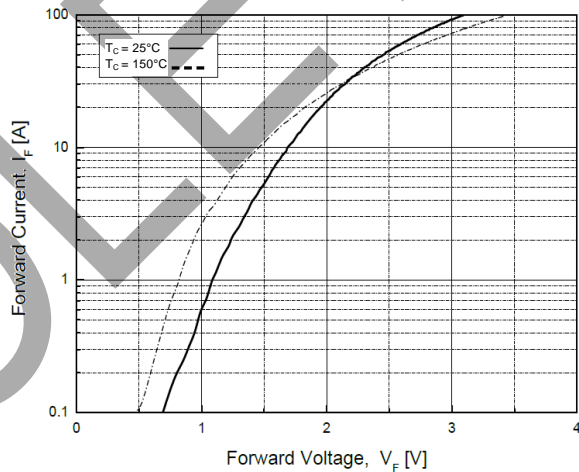


Fig.16 Diode Forward Characteristics

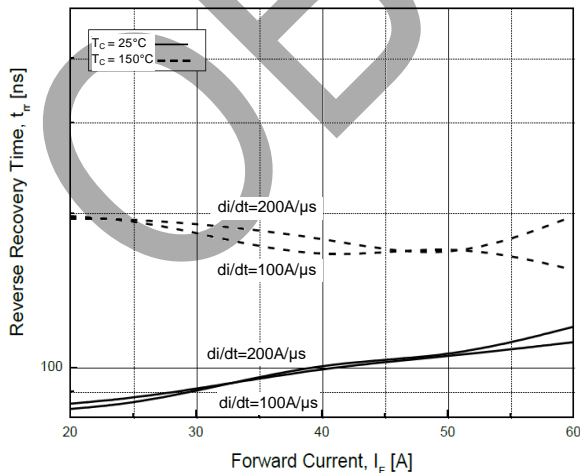


Fig.17 Typical Turn off-Collector Current

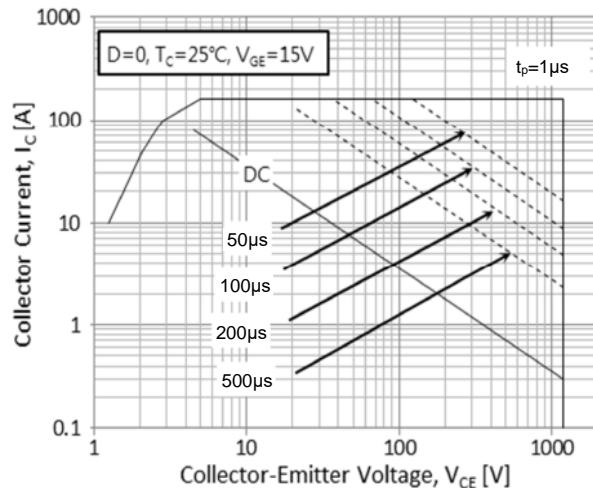


Fig.18 Forward Bias Safe Operating Area

Typical Performance Characteristics (continued)

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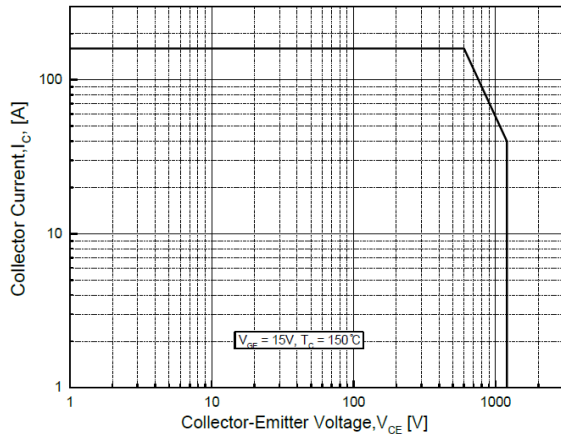


Fig.19 Reverse Bias Safe Operating Area

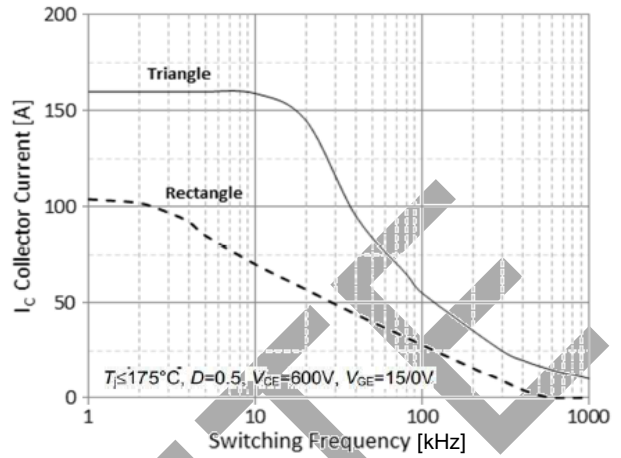


Fig.20 Switching frequency – Collector current

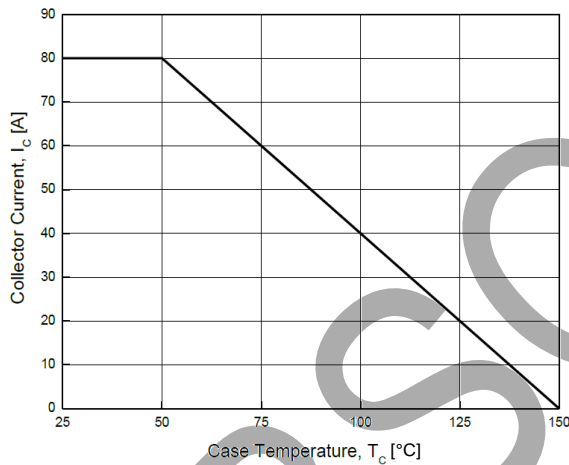


Fig.21 Case Temperature – Collector Current

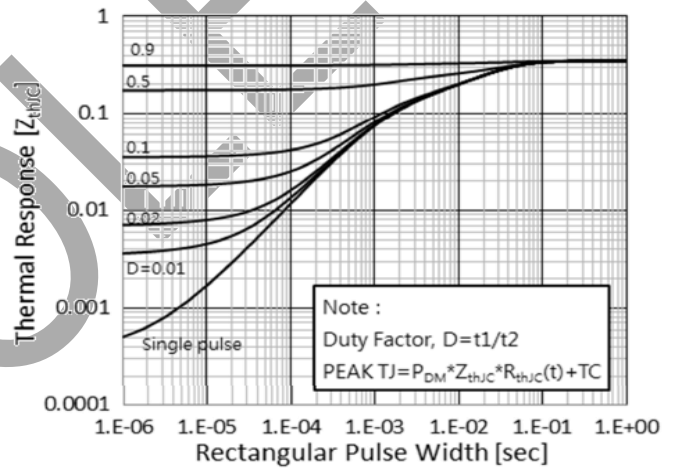
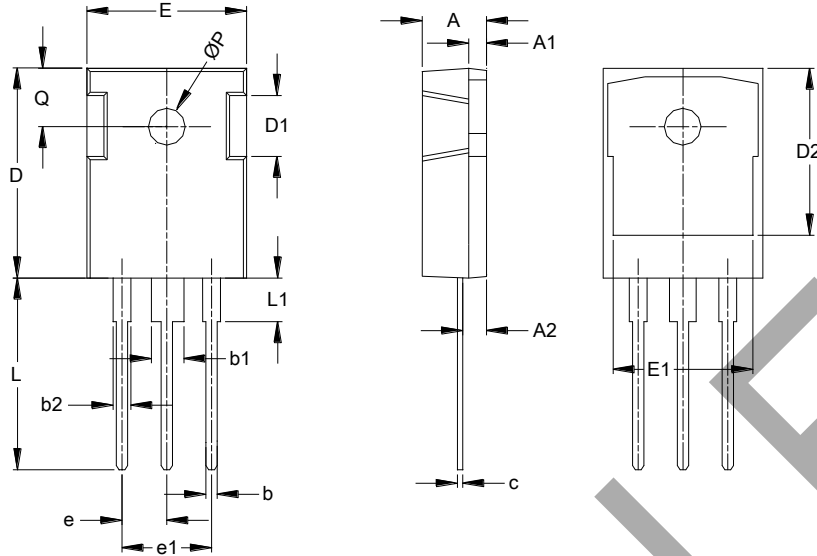


Fig.22 IGBT Transient Thermal Impedance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

TO247 (Type MC)



TO-247 (Type MC)			
Dim	Min	Max	Typ
A	4.700	5.310	-
A1	1.500	2.490	-
A2	2.200	2.600	-
b	0.990	1.400	-
b1	2.590	3.430	-
b2	1.650	2.390	-
c	0.380	0.890	-
D	20.30	21.46	-
D1	4.320	5.490	-
D2	13.08	-	-
E	15.45	16.26	-
E1	13.06	14.02	-
e	5.450		-
e1	10.90		-
L	19.81	20.57	-
L1	-	4.500	-
Q	5.380	6.200	-
øP	3.500	3.700	-
All Dimensions in mm			

Note: 7. For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.

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